



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

SB20-03P — Schottky Barrier Diode 30V, 2A Rectifier

Applications

- High frequency rectification (switching regulators, converters, choppers)

Features

- Low forward voltage ($V_F \text{ max}=0.55\text{V}$)
- Low switching noise
- Low leakage current and high reliability due to highly reliable planar structure
- Fast reverse recovery time ($t_{rr} \text{ max}=20\text{ns}$)

Specifications

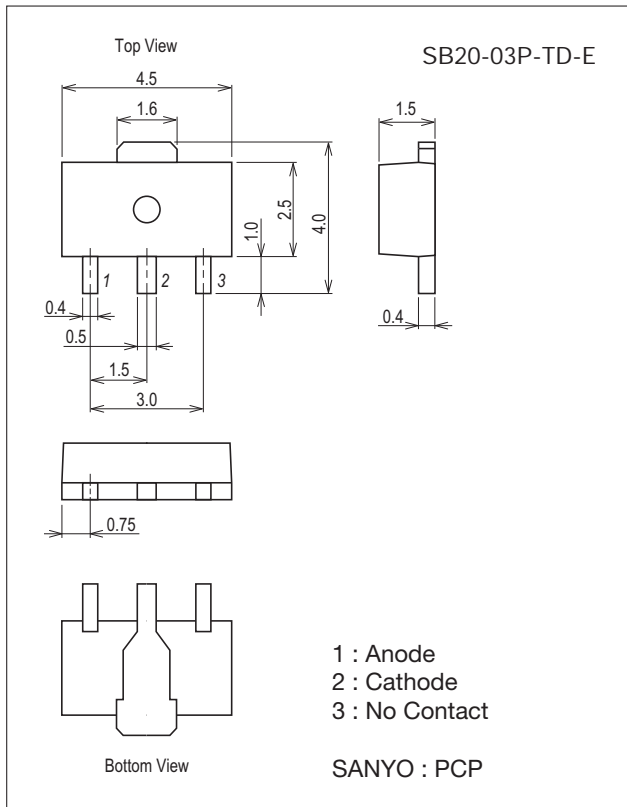
Absolute Maximum Ratings at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Repetitive Peak Reverse Voltage	V_{RRM}		30	V
Nonrepetitive Peak Reverse Surge Voltage	V_{RSM}		35	V
Average Output Current	I_O		2	A
Surge Forward Current	I_{FSM}	50Hz sine wave, 1 cycle	20	A
Junction Temperature	T_j		-55 to +125	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +125	$^\circ\text{C}$

Package Dimensions

unit : mm (typ)

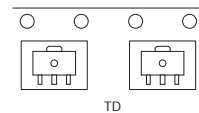
7007B-001



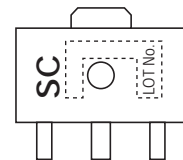
Product & Package Information

- Package : PCP
- JEITA, JEDEC : SC-62, SOT-89, TO-243
- Minimum Packing Quantity : 1,000 pcs./reel

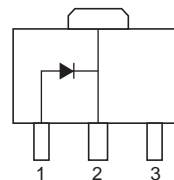
Packing Type: TD



Marking



Electrical Connection

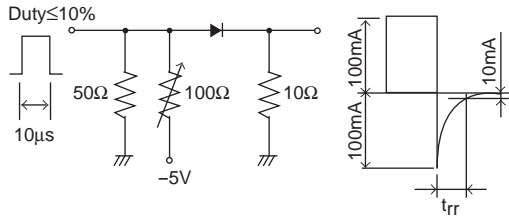


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Electrical Characteristics at $T_a=25^{\circ}\text{C}$

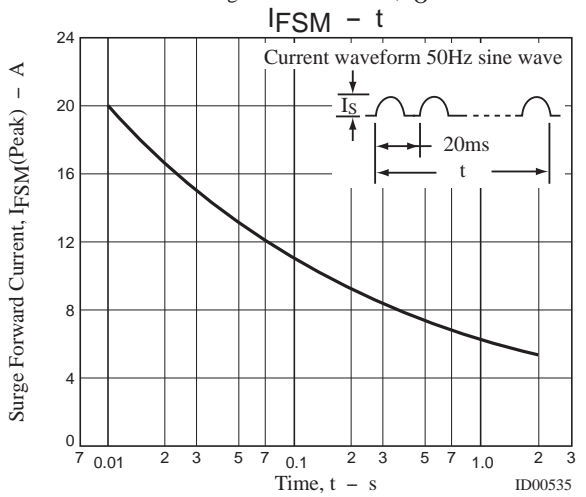
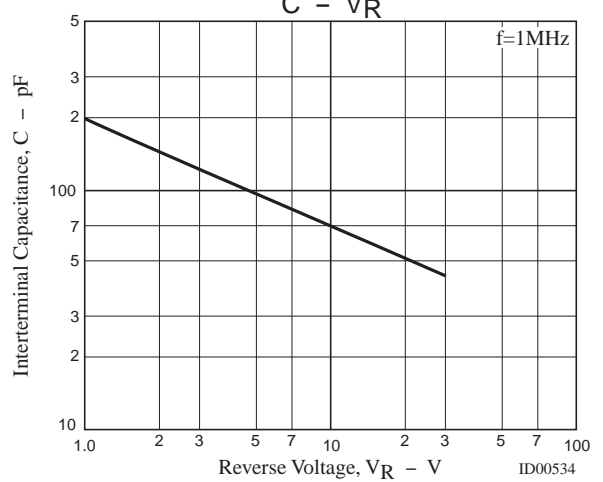
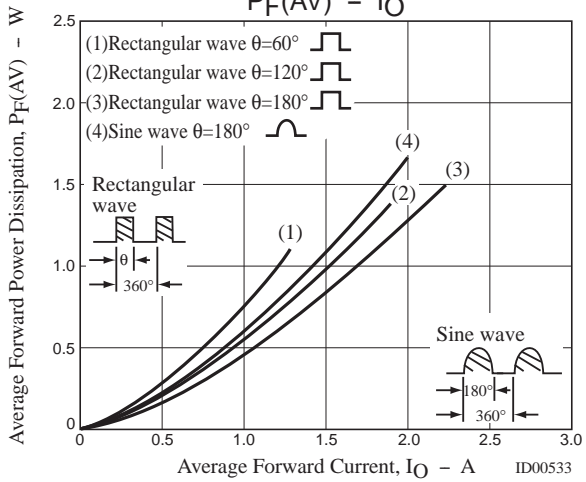
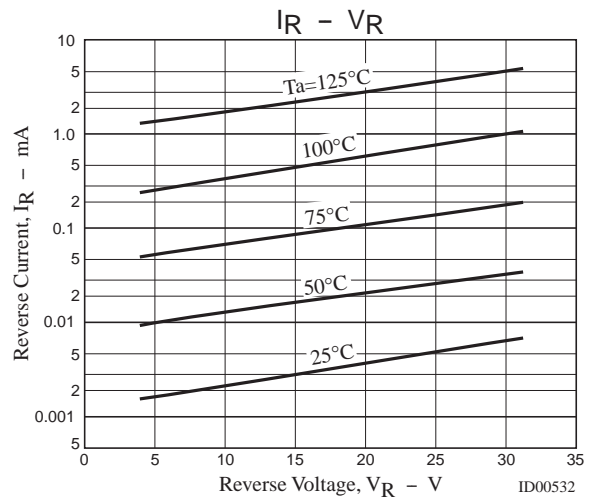
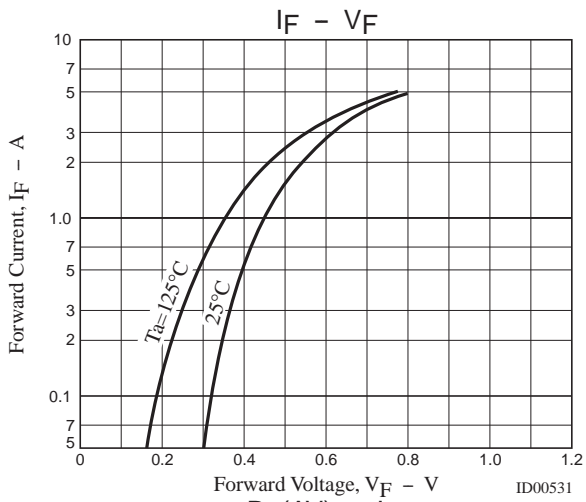
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Reverse Voltage	V_R	$I_R=500\mu\text{A}$	30			V
Forward Voltage	V_F	$I_F=2\text{A}$			0.55	V
Reverse Current	I_R	$V_R=15\text{V}$			100	μA
Interterminal Capacitance	C	$V_R=10\text{V}$, $f=1\text{MHz}$		70		pF
Reverse Recovery Time	t_{rr}	$I_F=I_R=100\text{mA}$, See specified Test Circuit.			20	ns
Thermal Resistance	$R_{th(j-a)1}$			300		$^{\circ}\text{C} / \text{W}$
	$R_{th(j-a)2}$	When mounted on ceramic substrate (250mm ² ×0.8mm)		110		$^{\circ}\text{C} / \text{W}$

t_{rr} Test Circuit



Ordering Information

Device	Package	Shipping	memo
SB20-03P-TD-E	PCP	1,000pcs./reel	Pb Free



Embossed Taping Specification

SB20-03P-TD-E

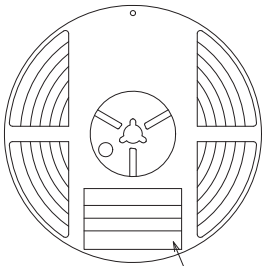
1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
PCP	PCP	1,000	4,000	24,000	4 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label
(unit : mm)

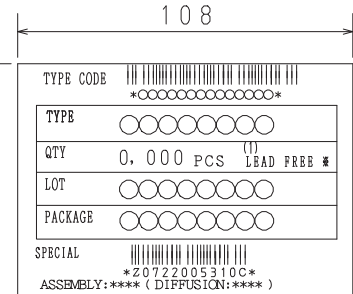
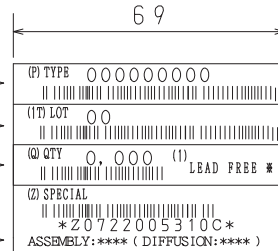
Outer box label
It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

Packing method



Reel label

Type No.
LOT No.
Quantity
Origin



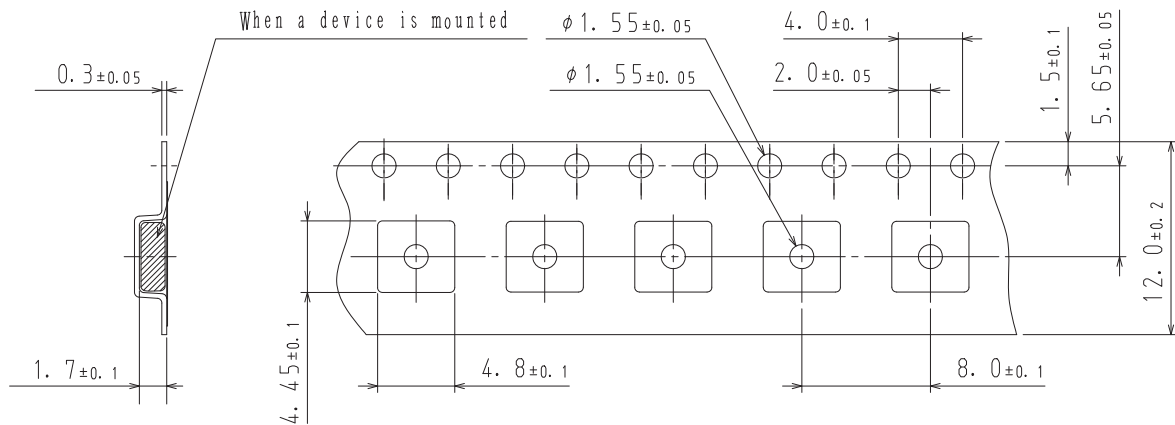
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

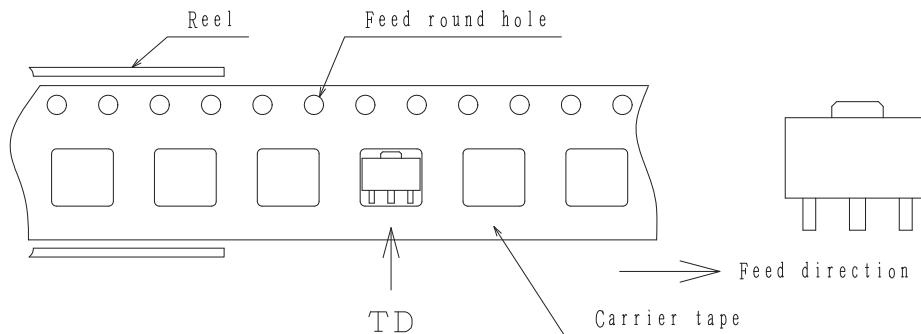
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



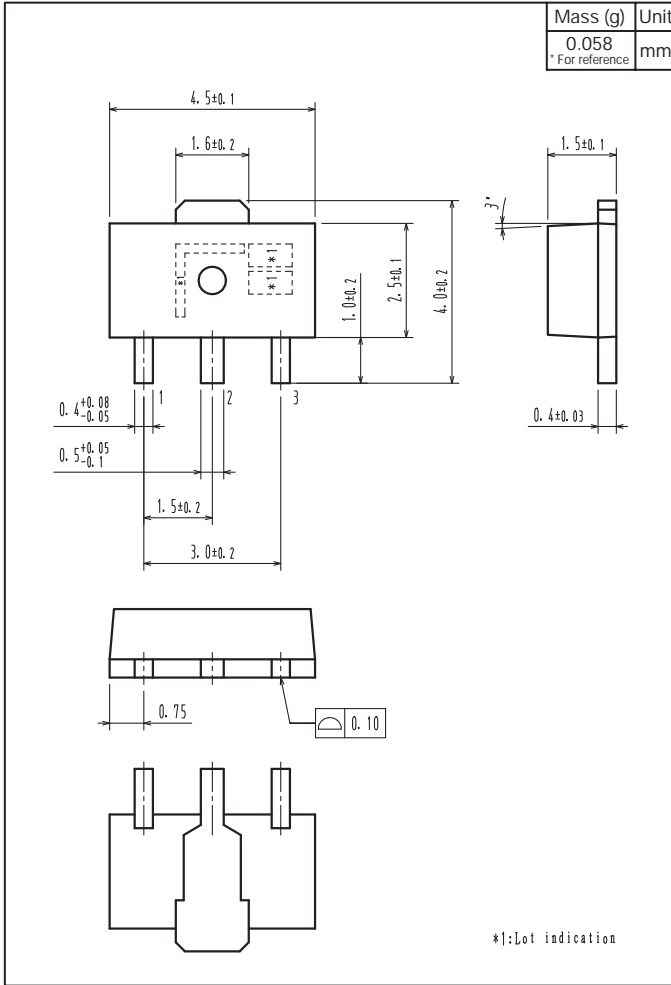
2-2. Device placement direction



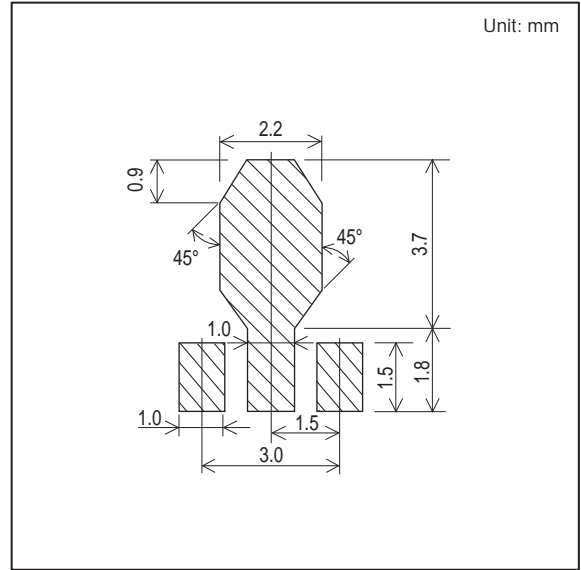
Those with pin 1 index on the feed hole side.....TD

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Outline Drawing SB20-03P-TD-E



Land Pattern Example



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